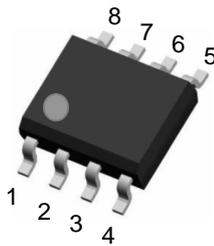


Dual P-Channel Enhancement-Mode MOSFET (-30V, -5.3A)

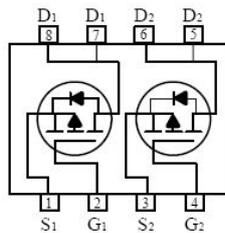
| PRODUCT SUMMARY | | |
|-----------------|-------|------------------------------------|
| V_{DS} | I_D | $R_{DS(on)}$ (m-ohm) Max |
| -30V | -5.3A | 60 @ $V_{GS} = -10V, I_D = -5.3A$ |
| | | 85 @ $V_{GS} = -4.5V, I_D = -3.9A$ |

Features

- Advanced Trench Process Technology
- High Density Cell Design for Ultra Low On-Resistance
- Surface mount Package
- Ordering information : KF4953 (Lead (Pb) -free)
KF4953-G (Lead (Pb) -free and halogen-free)



SOP-8



Pin 1: Source 2
Pin 2: Gate 2
Pin 3: Source 1
Pin 4: Gate 1
Pin 5 / 6: Drain 1
Pin 7 / 8: Drain 2

Absolute Maximum Ratings ($T_A = 25^\circ\text{C}$, unless otherwise noted)

| Symbol | Parameter | Ratings | Units |
|-----------------|---|-------------|--------------------|
| V_{DS} | Drain-Source Voltage | -30 | V |
| V_{GS} | Gate-Source Voltage | ± 20 | V |
| I_D | Drain Current (Continuous) | -5.3 | A |
| I_{DM} | Drain Current (Pulsed) ^a | -20 | A |
| P_D | Total Power Dissipation @ $T_A = 25^\circ\text{C}$ | 2.0 | W |
| I_S | Maximum Diode Forward Current | -2 | A |
| T_j, T_{stg} | Operating Junction and Storage Temperature Range | -55 to +150 | $^\circ\text{C}$ |
| $R_{\theta JA}$ | Thermal Resistance Junction to Ambient (PCB mounted) ^b | 50 | $^\circ\text{C/W}$ |

a: Repetitive Rating: Pulse width limited by the maximum junction temperature.
 b: 1-in² 2oz Cu PCB board